

Dual P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.) (nC)		
	0.450 at V _{GS} = -4.5 V	-0.55			
-20	0.500 at V _{GS} = -2.5 V	-0.50	1		
	0.600 at V _{GS} = -1.8 V	-0.38			

FEATURES

- TrenchFET® power MOSFET
- 100 % R tested
- Fast switching speed



APPLICATIONS

- Load / power switch for portable devices
- Drivers: relays, solenoids, displays
- Battery operated systems

	S	C-75-6		
S ₁	1	TIL	6	D ₁
G ₁	2	厂	5	G ₂
D ₂	3		4	S ₂
	To	op View		

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V _{DS}	-20	V		
Gate-Source Voltage		V_{GS}	± 8	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
Continuous Drain Current /T 150 °C)	T _A = 25 °C	- I _D	-0.55 b, c			
Continuous Drain Current (T _J = 150 °C)	T _A = 70 °C		-0.45 ^{b, c}	Ī ,		
Pulsed Drain Current (t = 300 μs)		I _{DM}	-1.8	Α Α		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	-0.16 ^{b, c}			
Maximum Power Dissipation	T _A = 25 °C	P _D	0.19 ^{b, c}	W		
waxiiiuiii Fowei Dissipatioii	T _A = 70 °C	, LD	0.12 ^{b, c}	T vv		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 5 s	R_{thJA}	440	530	°C/W	
iviaximum sunction-to-ambient 4, 2	Steady State		540	650		

Notes

- a. Maximum under steady state conditions is 650 $^{\circ}\text{C/W}.$
- b. Surface mounted on 1" x 1" FR4 board.
- $c. \ t=5 \ s.$

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} = 0, I _D = -250 μA	-20	_	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250A		-12	-	m\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	1.8	-	mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-	-1	V	
Cata Cauraa Laakas:	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 30		
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 1		
Zama Cata Waltana Basis Council	l	V _{DS} = -20 V, V _{GS} = 0 V	-	-	-1 μA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V, T _J = 85 °C	-	-	-10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-1.5	-	-	Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -0.4 \text{ A}$	-	0.450	-	<u>-</u> - Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = -2.5 V, I _D = -0.2 A	-	0.500	-		
		V _{GS} = -1.8 V, I _D = -0.1 A	-	0.600	-	1	
Forward Transconductance	9fs	$V_{DS} = -10 \text{ V}, I_D = 0.4 \text{ A}$	-	1	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	45	ı		
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	15	-	pF	
Reverse Transfer Capacitance	C _{rss}		-	10	ı		
Total Gate Charge	0	$V_{DS} =$ -10 V, $V_{GS} =$ -4.5 V, $I_D =$ -0.4 A	-	1.65	2.50		
Total Gate Charge	Qg		-	1	2	nC	
Gate-Source Charge	Q_{gs}	V_{DS} = -0 V, V_{GS} = -2.5 V, I_D = -0.4	-	0.2	ı		
Gate-Drain Charge	Q_{gd}		-	0.26	ı		
Gate Resistance	R_g	f = 1 MHz	2.4	12	24	Ω	
Turn-On Delay Time	t _{d(on)}		-	9	18		
Rise Time	t _r	$V_{DD} = -10~V,~R_L = 33.3~\Omega$ $I_D \cong -0.3~A,~V_{GEN} = -4.5~V,~R_g = 1~\Omega$	-	10	20		
Turn-Off DelayTime	t _{d(off)}		-	10	20		
Fall Time	t _f		-	8	16	ns	
Turn-On Delay Time	t _{d(on)}		-	1	2	113	
Rise Time	t _r	V_{DD} = -10 V, R_L = 33.3 Ω	-	8	16		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ -0.3 A, $V_{GEN}=$ -8 V, $R_g=$ 1 Ω	-	9	18		
Fall Time	t _f		-	5	10		
Drain-Source Body Diode Characteris	tics						
Pulse Diode Forward Current ^a	I _{SM}		-	-	-1.5	Α	
Body Diode Voltage	V_{SD}	$I_{S} = -0.3 \text{ A}$	-	-0.8	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	16	24	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 0.3 A dl/d+ = 100 A/vo	-	8	16	nC	
Reverse Recovery Fall Time	ta	$I_F = -0.3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$	-	11	-	ns	
Reverse Recovery Rise Time	t _b		-	5	-		

Notes

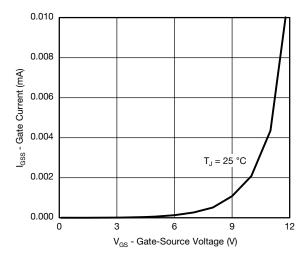
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

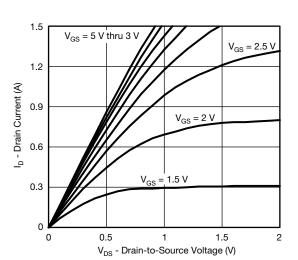
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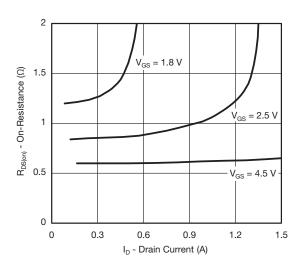
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



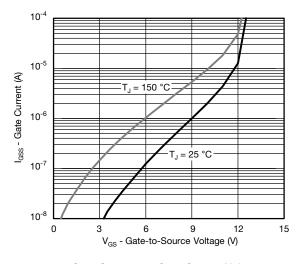
Gate Current vs. Gate-Source Voltage



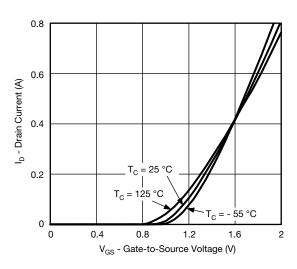
Output Characteristics



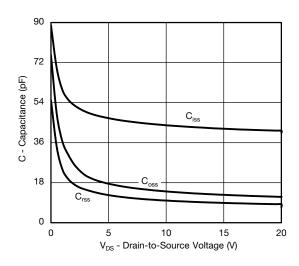
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



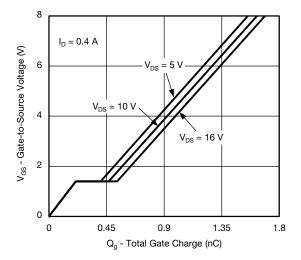
Transfer Characteristics



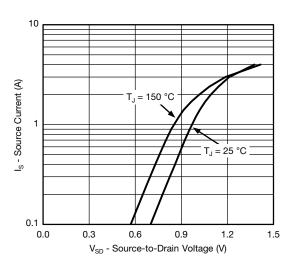
Capacitance



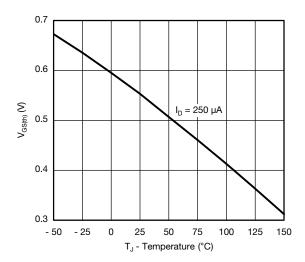
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



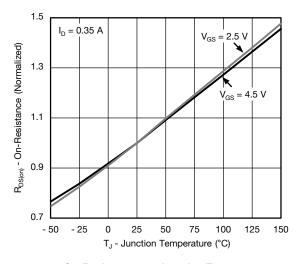
Gate Charge



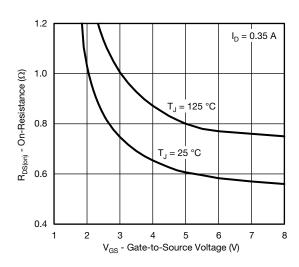
Source-Drain Diode Forward Voltage



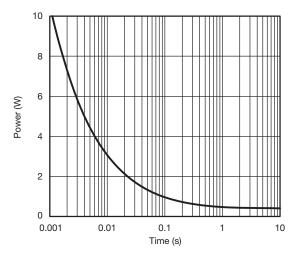
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

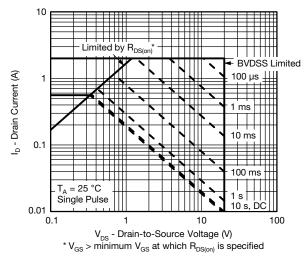


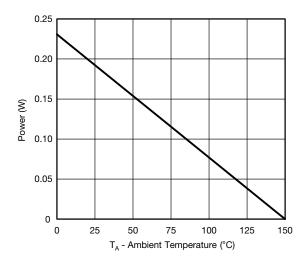
Single Pulse Power, Junction-to-Ambient

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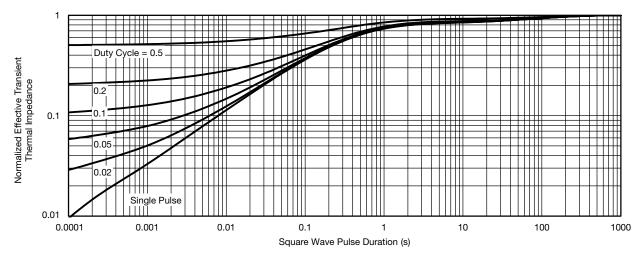
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Safe Operating Area, Junction-to-Ambient

Power Derating, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient

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